



#### **FEATURES**

- Member of the Texas Instruments Widebus™
   Family
- Operates From 1.65-V to 3.6-V V<sub>CC</sub>
- +24-mA Output Drive at 3.3-V V<sub>CC</sub>
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### **DESCRIPTION/ORDER INFORMATION**

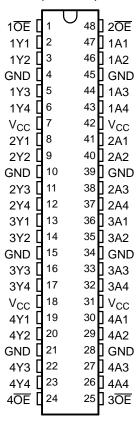
This 16-bit buffer/driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74ALVC16244A is designed specifically to improve the performance and density of 3-state memory-address drivers, clock drivers, and bus-oriented receivers and transmitters.

The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. It provides true outputs and symmetrical active-low output-enable  $(\overline{OE})$  inputs.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  shall be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

# DGG OR DL PACKAGE (TOP VIEW)



#### **ORDERING INFORMATION**

T <sub>A</sub>	PACKAGE <sup>(1)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	SSOP - DL		SN74ALVC16244ADL	ALVC16244A	
	330P - DL	Tape and reel	SN74ALVC16244ADLR	ALVG10244A	
-40°C to 85°C	TSSOP - DGG	Tape and reel	SN74ALVC16244ADGGR	ALVC16244A	
	VFBGA - GQL	Tana and saal	SN74ALVC16244AGQLR	VC044A	
	VFBGA - ZQL (Pb-free)	Tape and reel	SN74ALVC16244AZQLR	VC244A	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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## SN74ALVC16244A 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

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# GQL OR ZQL PACKAGE (TOP VIEW)

	_	1	2	3	4	5	6
Α		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
В		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
С		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
D		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
Ε		$\bigcirc$	$\bigcirc$			$\bigcirc$	$\bigcirc$
F		$\bigcirc$	$\bigcirc$			$\bigcirc$	$\bigcirc$
G		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
Н		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
J		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
K		$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$	$\bigcirc$
	•						

## TERMINAL ASSIGNMENTS(1)

	1	2	3	4	5	6
Α	1 <del>OE</del>	NC	NC	NC	NC	2 <del>OE</del>
В	1Y2	1Y1	GND	GND	1A1	1A2
С	1Y4	1Y3	V <sub>CC</sub>	V <sub>CC</sub>	1A3	1A4
D	2Y2	2Y1	GND	GND	2A1	2A2
Е	2Y4	2Y3			2A3	2A4
F	3Y1	3Y2			3A2	3A1
G	3Y3	3Y4	GND	GND	3A4	3A3
Н	4Y1	4Y2	V <sub>CC</sub>	V <sub>CC</sub>	4A2	4A1
J	4Y3	4Y4	GND	GND	4A4	4A3
K	4 <del>0E</del>	NC	NC	NC	NC	3 <del>OE</del>

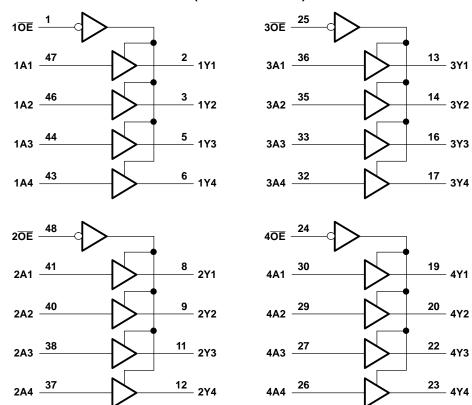
(1) NC - No internal connection

# FUNCTION TABLE (each 4-bit buffer)

INP	UTS	ОИТРИТ
ŌĒ	Α	(Y)
L	Н	Н
L	L	L
Н	Χ	Z



## **LOGIC DIAGRAM (POSTIVE LOGIC)**



Pin numbers shown are for the DGG and DL packages.

## ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range		-0.5	4.6	V
V <sub>I</sub>	Input voltage range <sup>(2)</sup>		-0.5	4.6	V
Vo	Output voltage range (2)(3)		-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
Io	Continuous output current	·		±50	mA
	Continuous current through each V <sub>CC</sub> or GND			±100	mA
		DGG package		70	
$\theta_{JA}$	Package thermal impedance <sup>(4)</sup>	DL package		63	°C/W
		GQL/ZQL package		42	
T <sub>stg</sub>	Storage temperature range	·	-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>(2)</sup> The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(3)</sup> This value is limited to 4.6 V, maximum.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

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## **RECOMMENDED OPERATING CONDITIONS<sup>(1)</sup>**

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		1.65	3.6	V
		V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		
$V_{IH}$	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2		
		V <sub>CC</sub> = 1.65 V to 1.95 V		$0.35 \times V_{CC}$	
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V		0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V		0.8	
V <sub>I</sub>	Input voltage	•	0	3.6	V
Vo	Output voltage		0	V <sub>CC</sub>	V
		V <sub>CC</sub> = 1.65 V		-4	
	High lavel autout august	V <sub>CC</sub> = 2.3 V		-12	A
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 2.7 V		-12	mA
		V <sub>CC</sub> = 3 V		-24	
		V <sub>CC</sub> = 1.65 V		4	
	Low lovel output ourrent	V <sub>CC</sub> = 2.3 V		12	mA
l <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 2.7 V		12	mA
		V <sub>CC</sub> = 3 V		24	
Δt/Δν	Input transition rise or fall rate	•		10	ns/V
T <sub>A</sub>	Operating free-air temperature		-40	85	°C

<sup>(1)</sup> All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

P.	ARAMETER	TEST CONDITIONS			MIN	TYP <sup>(1)</sup>	MAX	UNIT
		I <sub>OH</sub> = -100 μA		1.65 V to 3.6 V	V <sub>CC</sub> - 0.2			
		$I_{OH} = -4 \text{ mA}$		1.65 V	1.2			
		I <sub>OH</sub> = -6 mA	2.3 V	2				
V <sub>OH</sub>				2.3 V	1.7			V
		I <sub>OH</sub> = -12 mA		2.7 V	2.2			
				3 V	2.4			
		I <sub>OH</sub> = -24 mA	3 V	2				
		I <sub>OL</sub> = 100 μA		1.65 V to 3.6 V			0.2	
		I <sub>OL</sub> = 4 mA	1.65 V			0.45		
<b>\</b> ,,		I <sub>OL</sub> = 6 mA		2.3 V			0.4	v
V <sub>OL</sub>		1. 12	2.3 V			0.7	v	
		I <sub>OL</sub> = 12 mA	2.7 V			0.4		
		I <sub>OL</sub> = 24 mA		3 V			0.55	
I <sub>I</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND		3.6 V			±5	μA
I <sub>OZ</sub>		$V_O = V_{CC}$ or GND		3.6 V			±10	μA
Icc		$V_I = V_{CC}$ or GND,	I <sub>O</sub> = 0	3.6 V			40	μΑ
$\Delta I_{CC}$		One input at V <sub>CC</sub> - 0.6 V,	Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			750	μA
C	Control inputs	V – V or CND	221/		3		n.E	
C <sub>i</sub>	Data inputs	$V_I = V_{CC}$ or GND		3.3 V		6		pF
C <sub>o</sub>	Outputs	$V_O = V_{CC}$ or GND		3.3 V		7		pF

<sup>(1)</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C.

## SN74ALVC16244A 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

#### **SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 1.8 V	V <sub>CC</sub> = ± 0.	2.5 V 2 V	V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> = ± 0.	3.3 V 3 V	UNIT
	(INPUT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	А	Υ	(1)	1	3.7		3.6	1	3	ns
t <sub>en</sub>	ŌĒ	Υ	(1)	1	5.7		5.4	1	4.4	ns
t <sub>dis</sub>	ŌĒ	Y	(1)	1	5.2		4.6	1	4.1	ns

<sup>(1)</sup> This information was not avaliable at the time of publication.

## **OPERATING CHARACTERISTICS**

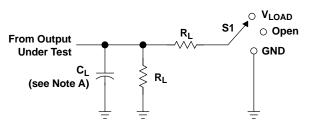
 $T_A = 25^{\circ}C$ 

	PARAMETER	1	TEST CONDITIONS	V <sub>CC</sub> = 1.8 V TYP	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	UNIT
	Power dissipation	Outputs enabled	C = 50 pF f = 10 MHz	(1)	16	19	nE
Cpd	capacitance	Outputs disabled	$C_L = 50 \text{ pF, f} = 10 \text{ MHz}$	(1)	4	5	pF

<sup>(1)</sup> This information was not avaliable at the time of publication.



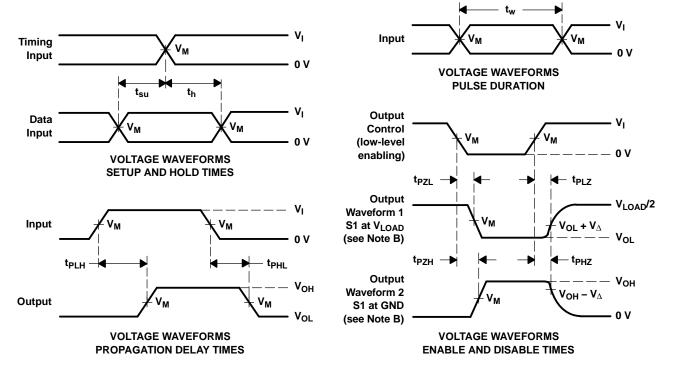
#### PARAMETER MEASUREMENT INFORMATION



TEST	<b>S</b> 1
t <sub>pd</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

LOAD CIRCUIT

V	IN	PUT	l v	\ ,	(	В	v
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	V <sub>LOAD</sub>	CL	R <sub>L</sub>	$oldsymbol{V}_{\Delta}$
1.8 V	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	<b>1 k</b> Ω	0.15 V
2.5 V $\pm$ 0.2 V	V <sub>CC</sub>	≤2 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3 V $\pm$ 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



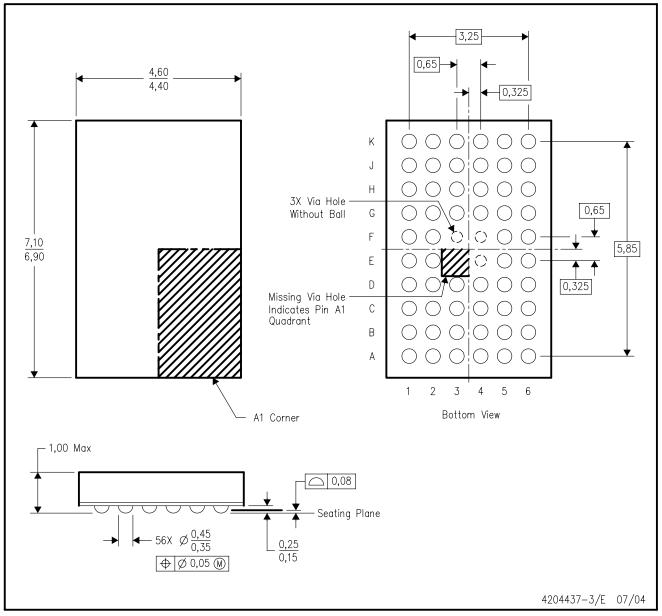
NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{\Omega}$  = 50  $\Omega$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

## ZQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY



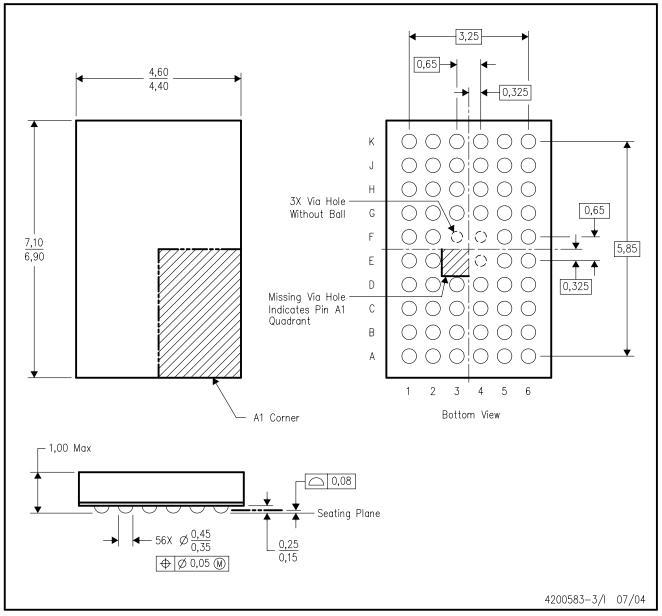
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BA.
- D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).



## GQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BA.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



## DL (R-PDSO-G\*\*)

#### **48 PINS SHOWN**

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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